

EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	("6538210").PN.	USPAT; USOCR	OR	OFF	2011/05/09 10:32
S1	0	((@ad<20011231)and(438/\$.ccls.or257/\$.CCLS)).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/07 16:32
S2	315398	(@AD<"20011231") AND ("257"/\$.CCLS. OR "438"/\$.CCLS.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/07 16:33
S3	7701	S2 and (buil\$2up or buil\$2in)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/07 16:34
S4	205	S3 and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/07 16:36
S5	2238	(@AD<"20011231") AND ("257"/686,777.CCLS. OR 438/109.CCLS.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/07 23:36
S6	44	S5 and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/07 23:37
S7	2030	((chip or die) with (carrier or interposer)) and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/07 23:42
S8	238	S7 and (@AD<"20011231") and (dielectric or insulat\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/07 23:43
S9	36	("5973391").URPN.	USPAT	OR	OFF	2011/05/08 08:32

S10	376227	(@AD<"20011231") AND ("257"/\$.CCLS. OR "438"/\$.CCLS. or "361"/\$.ccls.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 08:43
S11	4373	S10 and Inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 08:44
S12	2918	S11 and (dielectric or insulat\$3 or epoxy or encapsulat\$3 or encapsulant)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 08:45
S13	2247	S12 and (via or open\$3 or re\$2wiring or redistribution or redistributing)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 08:47
S14	52	S12 and (re\$2wiring or redistribution or redistributing)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 08:48
S15	52	("6538210").URPN.	USPAT	OR	OFF	2011/05/08 08:52
S16	0	("7884486").URPN.	USPAT	OR	OFF	2011/05/08 08:52
S17	52	("6538210").URPN.	USPAT	OR	OFF	2011/05/08 08:52
S18	49	("6873529").URPN.	USPAT	OR	OFF	2011/05/08 09:04
S19	2358	S12 and (via\$1 or open\$3 or trench\$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 09:10
S20	552	S19 and ((chip or die) with (interposer or carrier or board or substrate or pwb or pcb))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 09:11
S21	647	S12 and ((chip or die) with (interposer or carrier or board or substrate or pwb or pcb))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 09:12
S22	186	("5874770").URPN.	USPAT	OR	OFF	2011/05/08 12:31

S23	376227	(@AD<"20011231") AND ("257"/\$.CCLS. OR "438"/\$.CCLS. or "361"/\$.ccls.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 12:49
S24	4373	S23 and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 12:49
S25	2918	S24 and (dielectric or insulat\$3 or epoxy or encapsulat\$3 or encapsulant)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 12:49
S26	2358	S25 and (via\$1 or open\$3 or trench\$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 12:49
S27	552	S26 and ((chip or die) with (interposer or carrier or board or substrate or pwb or pcb))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 12:49
S28	647	S25 and ((chip or die) with (interposer or carrier or board or substrate or pwb or pcb))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 12:49
S29	95	S28 not S27	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 12:49
S30	177	(@ad<"20011231") and (csp or ((chip or wafer) adj (scale or level))) and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 13:33
S31	122	S30 NOT (S27 or S28)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 13:34
S32	2	("2003/0011049").URPN.	USPAT	OR	OFF	2011/05/08 13:54

S33	329	(@ad<"20011231") and (csp or chip or die) and (mcm or multi\$2chip) and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 21:48
S34	376227	(@AD<"20011231") AND ("257"/\$.CCLS. OR "438"/\$.CCLS. or "361"/\$.ccls.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 21:49
S35	4373	S34 and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 21:49
S36	2918	S35 and (dielectric or insulat\$3 or epoxy or encapsulat\$3 or encapsulant)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 21:49
S37	2358	S36 and (via\$1 or open\$3 or trench\$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 21:49
S38	552	S37 and ((chip or die) with (interposer or carrier or board or substrate or pwb or pcb))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 21:49
S39	647	S36 and ((chip or die) with (interposer or carrier or board or substrate or pwb or pcb))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 21:49
S40	95	S39 not S38	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 21:49
S41	177	(@ad<"20011231") and (csp or ((chip or wafer) adj (scale or level))) and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 21:49
S42	122	S41 NOT (S38 or S39)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 21:49

S43	198	S33 not (S39 or S40 or S41 or S42)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 21:49
S44	1494	(@ad<"20011231") and (chip adj inductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 22:38
S45	566	S44 and (dielectric or insulat\$3 or epoxy or encapsulat\$3 or encapsulant)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/08 22:39
S46	52	("6538210").URPN.	USPAT	OR	OFF	2011/05/08 22:51
S47	2722	(@ad<"20011231") and ("3-d" or "3xd" or "3d" or (three adj dimension\$2)) and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/09 00:25
S48	291	S47 and ((chip or die) with (substrate or board or pwb or pcb or carrier or interposer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/09 00:27
S49	36	(@ad<"20011231") and (257/228,276,447,460,502,621,e33.068,e21.068,e21.569,e23.067,e23.0174,e23.184,e23.19,e23.597.ccls.) and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/09 08:02
S50	76	(@ad<"20011231") and (257/74,278,502,621,e23.067,e23.174,e27.026.ccls. or 438/for.426..ccls.) and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/09 08:11
S51	54	S50 not S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/09 08:11
S52	30	(@ad<"20011231") and (chip adj board) and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/09 08:24

S53	14	(@ad<"20011231") and (embedded adj chip) and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/09 08:27
S54	259432	(@ad<"20011231") and (chip or die) and (interposer or carrier) inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/09 08:29
S55	2069	(@ad<"20011231") and (chip or die) and (interposer or carrier) and inductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/09 08:29
S56	1137	S55 and (dielectric or insulat\$3 or epoxy or encapsulat\$3 or encapsulant)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2011/05/09 08:29

EAST Search History (Interference)

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